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PATENT ASSIGNMENT COVER SHEET

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|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |

| Name | Execution Date |
|-----------------|----------------|
| DONG-YO JHENG | 03/21/2019 |
| KEN-HSIEN HSIEH | 11/07/2018 |
| SHIH-MING CHANG | 11/07/2018 |
| CHIH-JIE LEE | 11/07/2018 |
| SHUO-YEN CHOU | 11/07/2018 |
| RU-GUN LIU | 11/08/2018 |

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| City: | HSINCHU | |
| State/Country: | TAIWAN | |
| Postal Code: | 300-78 | |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 16057277 |

CORRESPONDENCE DATA

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| DATE SIGNED: | | 07/26/2019 | |

Total Attachments: 4

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ASSIGNMENT

WHEREAS, we,

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| | (6) | Ru-Gun Liu | of | Hsinchu County, Taiwan, Republic of China |
|---------|-----|-----------------|----|---|
| | (5) | Shuo-Yen Chou | of | Hualien County, Taiwan, Republic of China |
| | (4) | Chih-Jie Lee | of | Hsinchu, Taiwan, Republic of China |
| V | (3) | Shih-Ming Chang | of | Hsinchu, Taiwan, Republic of China |
| s. , | (2) | Ken-Hsien Hsieh | of | Taipei City, Taiwan, Republic of China |
| ۵ | (1) | Dong-Yo Jheng | of | Hsinchu, Taiwan, Republic of China |

have invented certain improvements in

OPTICAL PROXIMITY CORRECTION AND PHOTOMASKS

for which we have executed an application for Letters Patent of the United States of America,

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of even date filed herewith; and filed on <u>08-07-2018</u> and assigned application number <u>16/057,277</u>; and

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, Taiwan Semiconductor Manufacturing Co., Ltd., ("TSMC"), 8, Li-Hsin Rd. 6, Hsinchu Science Park, Hsinchu, Taiwan 300-78, Republic of China is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

PATENT REEL: 049872 FRAME: 0928

AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

| Inventor Name: | Dong-Yo Jheng | | |
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| Dated: | | Inventor Signature | |
| Inventor Name: | Shih-Ming Chang | | |
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| Dated: | | Inventor Signature | |
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| | | PATENT REEL: S049872 FRAM | C |

AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

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PATENT REEL: 049872 FRAME: 0930

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| Inventor Name: | Ru-Gun Liu | | |
| Residence Address: | No. 90, Chenggong 5 th St. Zhubei City, Hsinchu County 302 | , Taiwan, Republic of China | |
| Dated: Mark & | rold | Ru-Gm Lin | |
| ···· | | nventor Signature | |
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PATENT REEL: 049872 FRAME: 0931

RECORDED: 07/26/2019

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